

# KM23V32000B(E)TY/KM23S32000B(E)TY

## 32M-Bit (4Mx8 /2Mx16) CMOS MASK ROM

### FEATURES

- Switchable organization  
4,194,304 x 8(byte mode)  
2,097,152 x 16(word mode)
- Fast access time  
Random Access Time  
3.3V Operation : 80ns(max.)  
3.0V Operation : 100ns(max.)  
2.5V Operation : 120ns(max.)
- Supply voltage  
KM23V32000B(E)TY : 2.7V ~ 3.6V  
KM23S32000B(E)TY : 2.3V ~ 2.7V
- Current consumption  
Operating : 30mA(max.)  
Standby : 30µA(max.)
- Fully static operation  
All inputs and outputs TTL compatible
- Three state outputs
- Package  
-. KM23V(S)32000B(E)TY : 48-TSOP1-1218

### GENERAL DESCRIPTION

The KM23V32000B(E)TY and KM23S32000B(E)TY are fully static mask programmable ROM fabricated using silicon gate CMOS process technology, and is organized either as 4,194,304 x 8 bit(byte mode) or as 2,097,152 x 16 bit(word mode) depending on BHE voltage level.(See mode selection table)

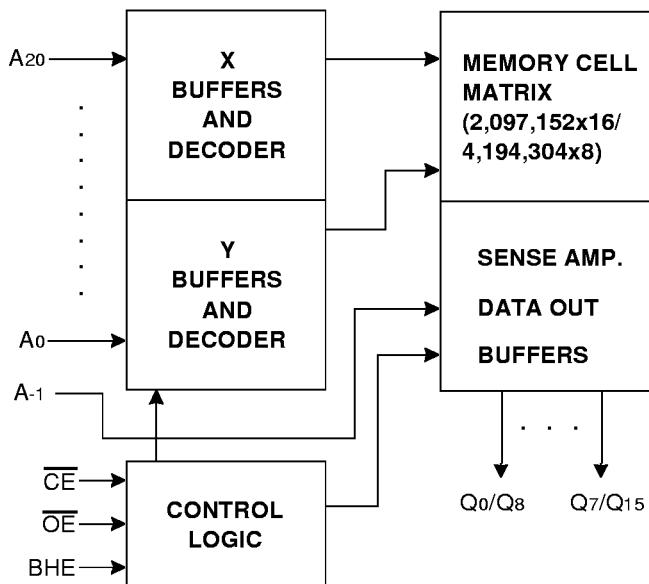
This device operates with low power supply, and all inputs and outputs are TTL compatible.

Because of its asynchronous operation, it requires no external clock assuring extremely easy operation.

It is suitable for use in program memory of microprocessor, and data memory, character generator.

The KM23V32000B(E)TY and KM23S32000B(E)TY are packaged in a 48-TSOP1.

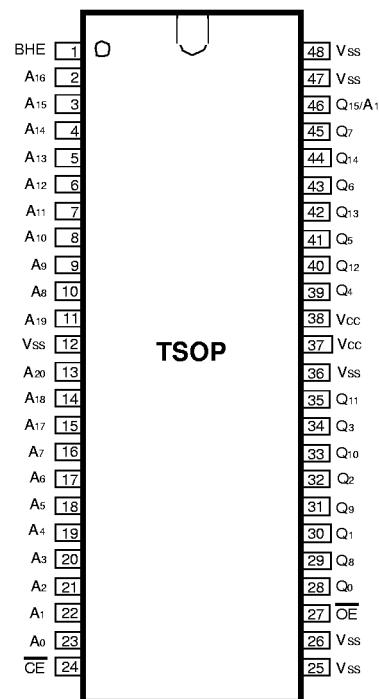
### FUNCTIONAL BLOCK DIAGRAM



Pin Name	Pin Function
A0 - A20	Address Inputs
Q0 - Q14	Data Outputs
Q15 /A-1	Output 15(Word mode)/ LSB Address(Byte mode)
BHE	Word/Byte selection
$\overline{CE}$	Chip Enable
$\overline{OE}$	Output Enable
Vcc	Power
Vss	Ground
N.C	No Connection

**KM23V32000B(E)TY/KM23S32000B(E)TY****32M-Bit (4Mx8 /2Mx16) CMOS MASK ROM****PRODUCT INFORMATION**

Product	Operating Temp Range	Vcc Range	Speed (ns)
KM23V32000BTY	0 i ~ 70 i	3.3V/3.0V	80/100
KM23S32000BTY		2.5V	120
KM23V32000BETY	-20 i ~ 85 i	3.3V/3.0V	80/100
KM23S32000BETY		2.5V	120

**PIN CONFIGURATION****TSOP**

**KM23V32000B(E)TY  
KM23S32000B(E)TY**

**ABSOLUTE MAXIMUM RATINGS**

Item	Symbol	Rating	Unit	Remark
Voltage on Any Pin Relative to Vss	V <sub>IN</sub>	-0.3 to +4.5	V	-
Temperature Under Bias	T <sub>BIAS</sub>	-55 to +150	i	-
Storage Temperature	T <sub>Stg</sub>	-55 to +150	i	-
Operating Temperature	T <sub>a</sub>	0 to +70	i	KM23V32000BTY KM23S32000BTY
		-20 to +85	i	KM23V32000BETY KM23S32000BETY

**NOTE :** Permanent device damage may occur if "ABSOLUTE MAXIMUM RATINGS" are exceeded. Functional operation should be restricted to the conditions as detailed in the operational sections of this data sheet. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## KM23V32000B(E)TY/KM23S32000B(E)TY

### RECOMMENDED OPERATING CONDITIONS (Voltage reference to Vss)

Item	Symbol	Min	Typ	Max	Unit
Supply Voltage	Vcc	2.7/3.0	3.0/3.3	3.3/3.6	V
		2.3	2.5	2.7	V
Supply Voltage	Vss	0	0	0	V

### DC CHARACTERISTICS

Parameter	Symbol	Test Conditions			Min	Max	Unit		
Operating Current	Icc	$\overline{CE}=\overline{OE}=VIL$ all outputs open	Vcc=3.3V; 0.3V	-	30	mA			
			Vcc=3.0V; 0.3V	-	25	mA			
			Vcc=2.5V; 0.2V	-	20	mA			
Standby Current(TTL)	ISB1	KM23V32000B(E)TY	$\overline{CE}=Vih$ , all outputs open		-	500	S,		
		KM23S32000B(E)TY	$\overline{CE}=Vih$ , all outputs open		-	100	S,		
Standby Current(CMOS)	ISB2	KM23V32000B(E)TY	$\overline{CE}=Vcc$ , all outputs open		-	30	S,		
		KM23S32000B(E)TY	$\overline{CE}=Vcc$ , all outputs open		-	5	S,		
Input Leakage Current	ILI	VIN=0 to Vcc			-	10	S,		
Output Leakage Current	ILO	VOUT=0 to Vcc			-	10	S,		
Input High Voltage, All Inputs	VIH				2.0	Vcc+0.3	V		
Input Low Voltage, All Inputs	VIL	KM23V32000B(E)TY				-0.3	0.6		
		KM23S32000B(E)TY				-0.3	0.4		
Output High Voltage Level	VOH	KM23V32000B(E)TY	IOH = -400S,	2.4		-	V		
		KM23S32000B(E)TY	IOH = -400S,	2.0		-	V		
Output Low Voltage Level	VOL	IOL = 2.1mA			-	0.4	V		

**NOTE :** Minimum DC Voltage(VIL) is -0.3V an input pins. During transitions, this level may undershoot to -2.0V for periods <20ns.

Maximum DC voltage on input pins(VIH) is Vcc+0.3V which, during transitions, may overshoot to Vcc+2.0V for periods <20ns.

### MODE SELECTION

$\overline{CE}$	$\overline{OE}$	BHE	Q15/A-1	Mode	Data	Power
H	X	X	X	Standby	High-Z	Standby
L	H	X	X	Operating	High-Z	Active
L	L	H	Output	Operating	Q0~Q15 : Dout	Active
		L	Input	Operating	Q0~Q7 : Dout Q8~Q14 : Hi-Z	Active

### CAPACITANCE ( TA =25°C , f=1.0MHz)

Item	Symbol	Test Conditions	MIN	Max	Unit
Output Capacitance	COUT	VOUT=0V	-	12	pF
Input Capacitance	CIN	VIN=0V	-	12	pF

**NOTE :** Capacitance is periodically sampled and not 100% tested.

## KM23V32000B(E)TY/KM23S32000B(E)TY

**AC CHARACTERISTICS** ( $V_{CC} = 3.3V/3.0V; 0.3V$ ,  $V_{CC} = 2.5V; 0.2V$ , unless otherwise noted.)

### TEST CONDITIONS

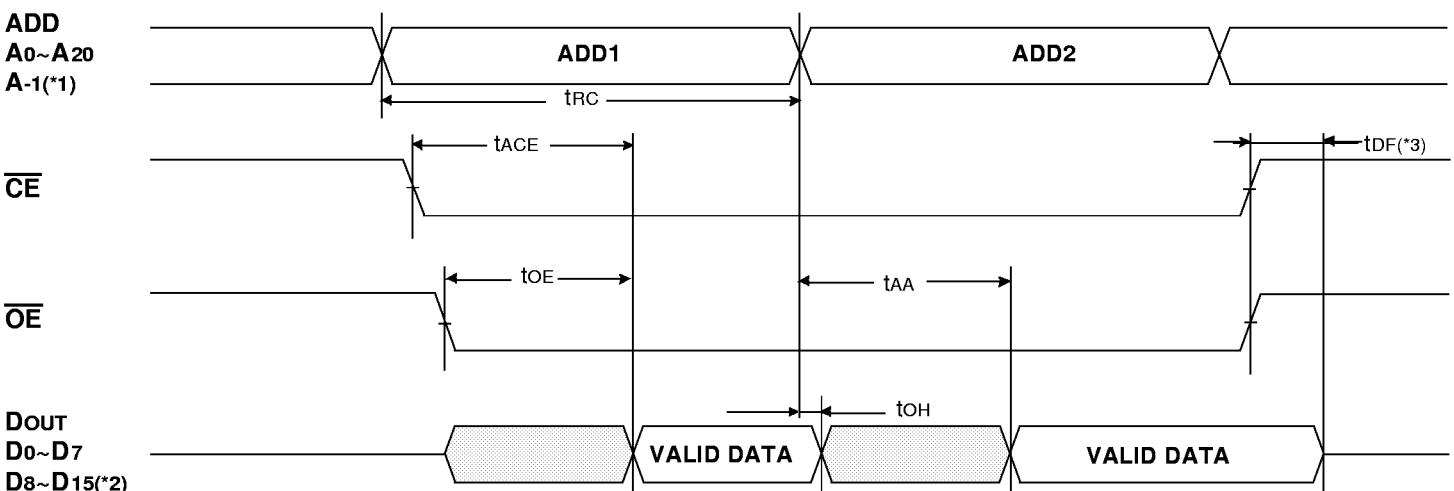
Item	Value
Input Pulse Levels	0.45V to 2.4V(at $V_{CC}=3.3V/3.0V$ )
	0.4V to 2.2V (at $V_{CC}=2.5V$ )
Input Rise and Fall Times	10ns
Input and Output timing Levels	1.5V (at $V_{CC}=3.3V/3.0V$ )
	1.1V (at $V_{CC}=2.5V$ )
Output Loads	1 TTL Gate and $C_L=100pF$

### READ CYCLE

Item	Symbol	$V_{CC} = 3.3V; 0.3V$		$V_{CC} = 3.0V; 0.3V$		$V_{CC} = 2.5V; 0.2V$		Unit
		Min	Max	Min	Max	Min	Max	
Read Cycle Time	tRC	80		100		120		ns
Chip Enable Access Time	tACE			80		100		120
Address Access Time	tAA			80		100		120
Output Enable Access Time	tOE			30		50		60
Output or Chip Disable to Output High-Z	tDF			20		20		20
Output Hold from Address Change	tOH	0		0		0		ns

### TIMING DIAGRAM

#### READ



**NOTES :** \*1. Byte Mode only. A-1 is Least Significant Bit Address.(BHE = VIL)

\*2. Word Mode only.(BHE = VIH)

\*3. tDF is defined as the time at which the outputs achieve the open circuit condition and is not referenced to VOH or VOL level.